

MOSFET

600V CoolMOS™ SJ S7 Power Device

IPP60R022S7 enables the best price performance for low frequency switching applications. CoolMOS™ S7 boasts the lowest Rdson values for a HV SJ MOSFET, with distinctive increase of energy efficiency.

CoolMOS™ S7 is optimized for "static switching" and high current applications. It is an ideal fit for solid state relay and circuit breaker designs as well as for line rectification in SMPS and inverter topologies.

Features

- CoolMOS $^{\text{TM}}$ S7 technology enables $22m\Omega$ R_{DS(on)} in the smallest footprint
- Optimized price performance in low frequency switching applications
- · High pulse current capability
- TO220 package with total Pb-free die attach

Benefits

- Minimized conduction losses (eliminate / reduce heat sink)
- Increased system performance
- More compact and easier design
- Lower BOM or/and TCO over prolonged life time

Compared to electromechanical devices:

- Faster switching times
- · More reliability and longer system life time
- Shock & Vibration resistance
- · No contact arcing, bouncing or degradation over life time

Potential applications

- Solid state relays and circuit breakers
- Line rectification in high power/performance applications e.g. Computing, Telecom, UPS and Solar

Product validation

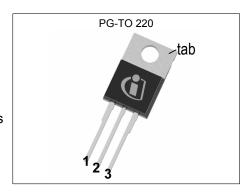
Fully qualified according to JEDEC for Industrial Applications

Please note: For MOSFET paralleling the use of ferrite beads on the gate or separate totem poles is generally recommended.



Parameter	Value	Unit
R _{DS(on),max}	22	mΩ
$Q_{g,typ}$	150	nC
V _{SD}	0.83	V
Pulsed I _{SD} , I _{DS}	375	A

Type / Ordering Code	Package	Marking	Related Links
IPP60R022S7	PG-TO220-3	60R022S7	see Appendix A



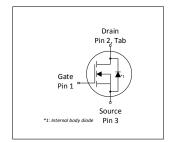












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1 Maximum ratings at $T_j = 25$ °C, unless otherwise specified

Table 2 **Maximum ratings**

Davamatav	Cumbal		Value	s	l lmi4	N	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain current rating	I _D	-	-	23	A	T_C =140°C Current is limited by $T_{j max}$ = 150°C; Lower case temp does increase current capability	
Pulsed drain current ¹⁾	I _{D,pulse}	-	-	375	Α	T _C =25°C	
Avalanche energy, single pulse	E _{AS}	-	-	289	mJ	I _D =3.8A; V _{DD} =50V; see table 10	
Avalanche current, single pulse	I _{AS}	-	-	3.8	Α	-	
MOSFET dv/dt ruggedness ²⁾	dv/dt	-	-	20	V/ns	V _{DS} = 0V to 300V	
Gate source voltage (static)	V _{GS}	-20	-	20	V	static	
Gate source voltage (dynamic)	V _{GS}	-30	-	30	V	AC (f>1 Hz)	
Power dissipation	P _{tot}	-	-	390	W	<i>T</i> _C =25°C	
Storage temperature	$T_{ m stg}$	-55	-	150	°C	-	
Operating junction temperature	T _j	-55	-	150	°C	-	
Mounting torque	-	-	-	60	Ncm	M3 and M3.5 screws	
Diode forward current rating	I _S	-	-	23	A	T_C =140°C Current is limited by $T_{j max}$ = 150°C; Lower case temp does increase current capability	
Diode pulse current ¹⁾	I _{S,pulse}	-	-	375	Α	T _C =25°C	
Reverse diode dv/dt ³⁾	dv/dt	-	-	5	V/ns	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=23A, $T_{\rm j}$ =25°C see table 8	
Maximum diode commutation speed	di _f /dt	-	-	820	A/μs	$V_{\rm DS}$ =0 to 300V, $I_{\rm SD}$ <=23A, $T_{\rm j}$ =25°C see table 8	
Insulation withstand voltage	V _{ISO}	-	-	n.a.	V	V _{rms} , T _C =25°C, t=1min	

 $^{^{1)}}$ Pulse width t_p limited by $T_{j,\text{max}}$ $^{2)}$ The dv/dt has to be limited by appropriate gate resistor $^{3)}$ Identical low side and high side switch

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2 Thermal characteristics

Table 3 Thermal characteristics

Doromotor	Cumbal	Values			11:4	Nata / Tank Canadikian	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Thermal resistance, junction - case	R _{thJC}	-	-	0.32	°C/W	-	
Thermal resistance, junction - ambient		-	-	62	°C/W	leaded	
Thermal resistance, junction - ambient for SMD version	R _{thJA}	-	-	-	°C/W	n.a.	
Soldering temperature, wavesoldering only allowed at leads	T_{sold}	-	-	260	°C	1.6mm (0.063 in.) from case for 10s	

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3 Electrical characteristics

at T_i =25°C, unless otherwise specified

Table 4 Static characteristics

For applications with applied blocking voltage >70% of the specified blocking voltage, it is required that the customer evaluates the impact of cosmic radiation effect in early design phase and contacts the Infineon sales office for the necessary technical support by Infineon

Danamatan	Cumbal	Values			I I mid	Note / Total Constitution
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	600	-	-	V	V_{GS} =0V, I_{D} =1mA
Gate threshold voltage	$V_{(GS)th}$	3.5	4.0	4.5	V	$V_{\rm DS}=V_{\rm GS},\ I_{\rm D}=1.44{\rm mA}$
Zero gate voltage drain current	I _{DSS}	-	- 50	5	μΑ	V _{DS} =600V, V _{GS} =0V, T _j =25°C V _{DS} =600V, V _{GS} =0V, T _j =150°C
Gate-source leakage current	I _{GSS}	-	-	100	nA	V _{GS} =20V, V _{DS} =0V
Drain-source on-state resistance	R _{DS(on)}	-	0.02 0.047	0.022	Ω	V _{GS} =12V, I _D =23A, T _j =25°C V _{GS} =12V, I _D =23A, T _j =150°C
Gate resistance	R _G	-	0.80	-	Ω	f=1MHz, open drain

Table 5 Dynamic characteristics

Parameter	0	Values			11		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Input capacitance	Ciss	-	5639	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Output capacitance	Coss	-	89	-	pF	V _{GS} =0V, V _{DS} =300V, f=250kHz	
Effective output capacitance, energy related ¹⁾	C _{o(er)}	-	303	-	pF	V _{GS} =0V, V _{DS} =0 to 300V	
Effective output capacitance, time related ²⁾	C _{o(tr)}	-	2678	-	pF	I_D =constant, V_{GS} =0V, V_{DS} =0 to 300V	
Output charge	Qoss	-	803	-	nC	V _{GS} =0V, V _{DS} =0 to 300V	
Turn-on delay time	t _{d(on)}	-	30	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Rise time	t _r	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Turn-off delay time	$t_{\sf d(off)}$	-	150	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9	
Fall time	t _f	-	9	-	ns	$V_{\rm DD}$ =300V, $V_{\rm GS}$ =13V, $I_{\rm D}$ =23A, $R_{\rm G}$ =5.3 Ω ; see table 9	

Table 6 Gate charge characteristics

Parameter	Symbol	Values			l lmi4	Note / Test Condition
	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	31	-	nC	V_{DD} =300V, I_{D} =23A, V_{GS} =0 to 12V
Gate to drain charge	$Q_{ m gd}$	-	50	-	nC	V_{DD} =300V, I_{D} =23A, V_{GS} =0 to 12V
Gate charge total	Q g	-	150	-	nC	V_{DD} =300V, I_{D} =23A, V_{GS} =0 to 12V
Gate plateau voltage	V _{plateau}	-	5.4	-	V	$V_{\rm DD}$ =300V, $I_{\rm D}$ =23A, $V_{\rm GS}$ =0 to 12V

 $^{^{1)}}$ $C_{\text{o(er)}}$ is a fixed capacitance that gives the same stored energy as C_{oss} while V_{DS} is rising from 0 to 300V $^{2)}$ $C_{\text{o(tr)}}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 to 300V

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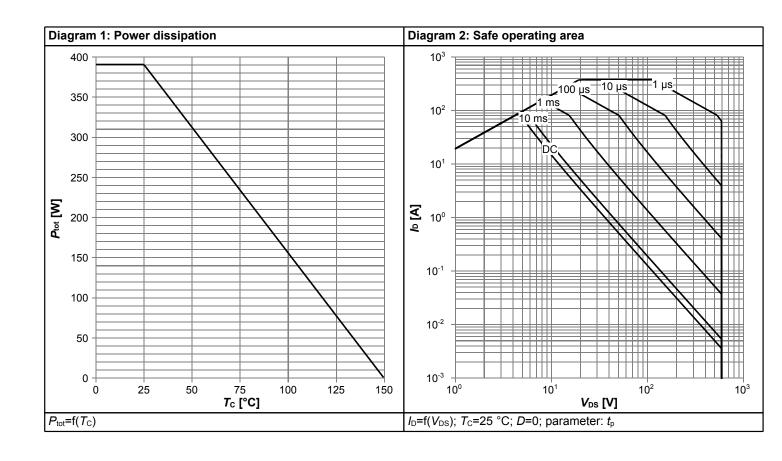


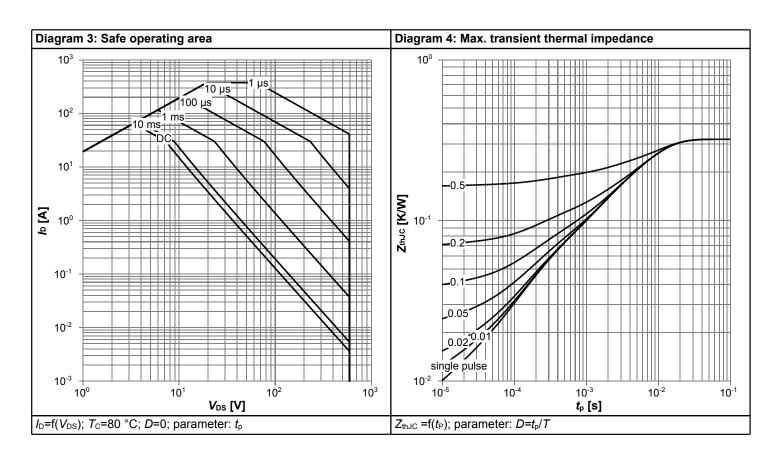
Table 7 Reverse diode characteristics

Davamatav	Cumbal	Values			11:4	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode forward voltage	V _{SD}	-	0.83	-	V	V _{GS} =0V, I _F =23A, T _j =25°C
Reverse recovery time	t _{rr}	-	460	-	ns	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8
Reverse recovery charge	Q _{rr}	-	9	-	μC	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8
Peak reverse recovery current	I _{rrm}	-	40	_	А	V_R =300V, I_F =23A, di_F/dt =100A/ μ s; see table 8

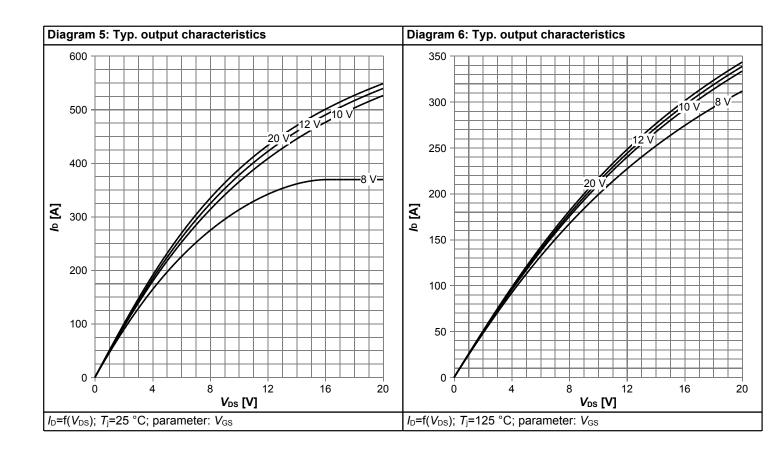


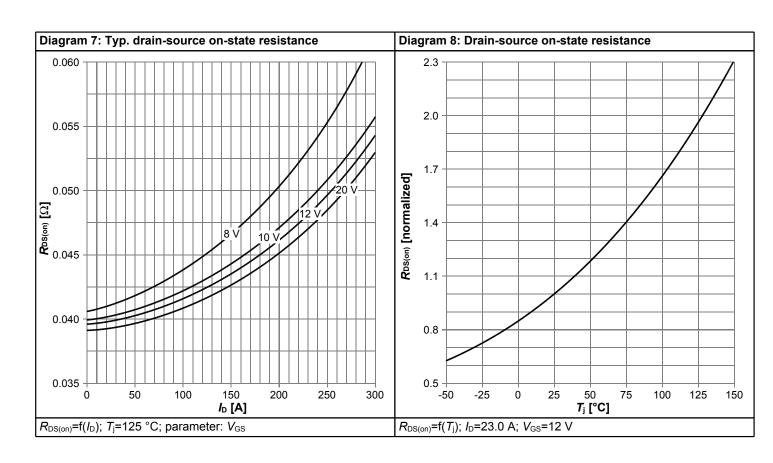
4 Electrical characteristics diagrams



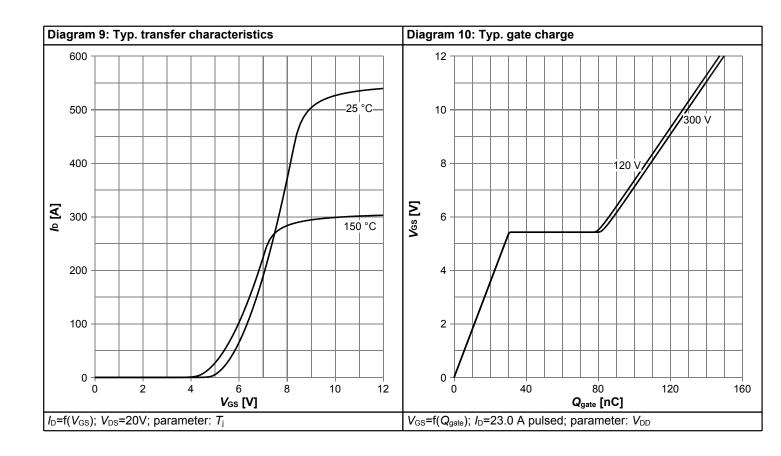


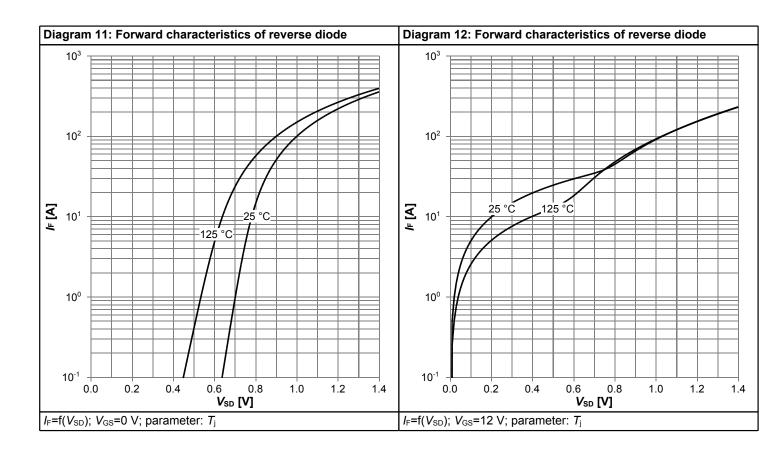




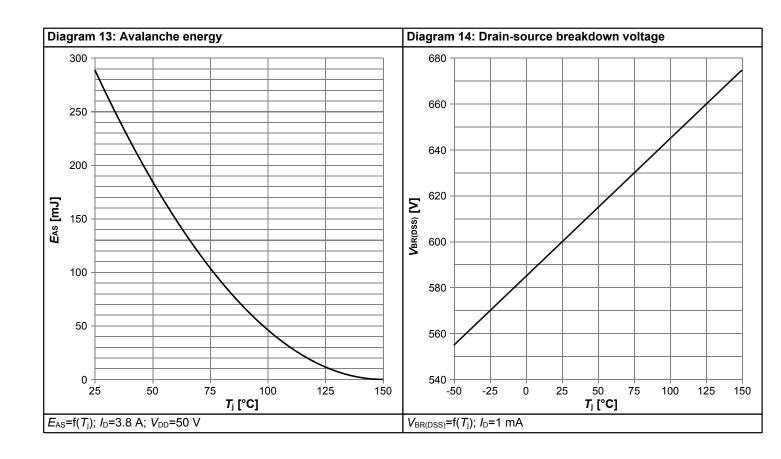


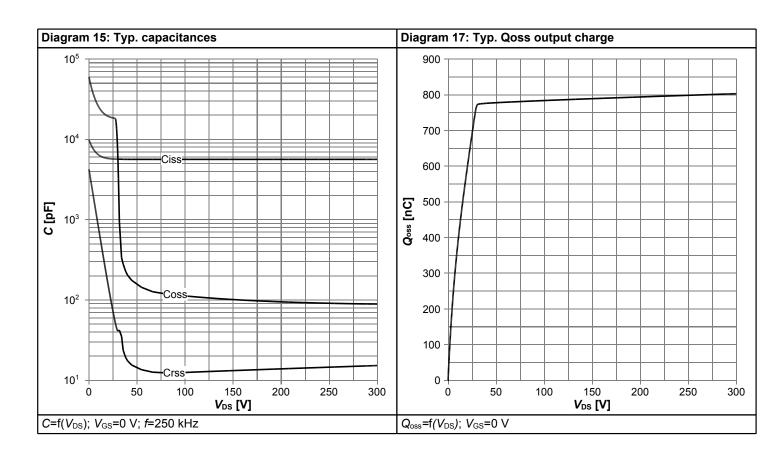














5 Test Circuits

Table 8 Diode characteristics

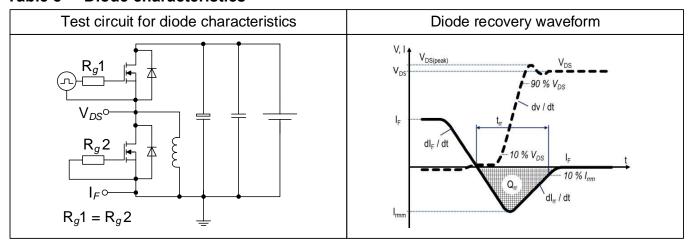


Table 9 Switching times



Table 10 Unclamped inductive load





6 Package Outlines

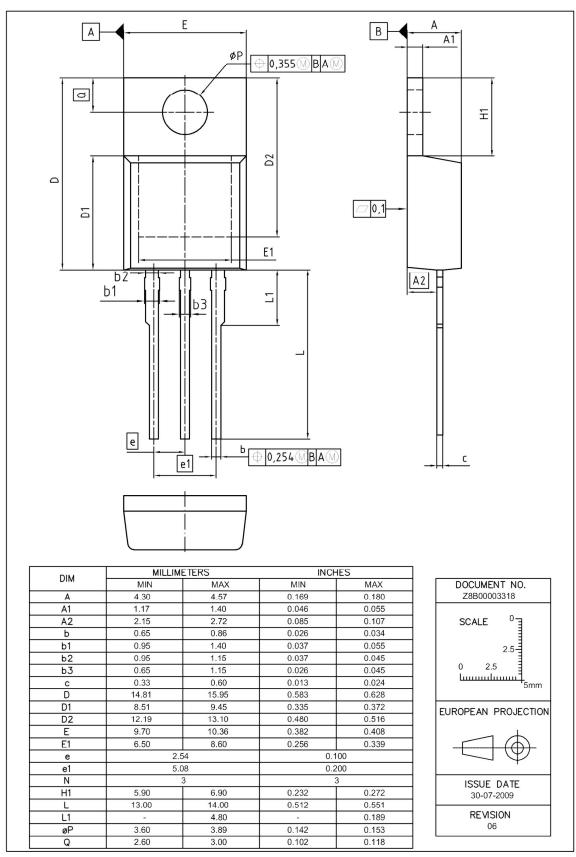


Figure 1 Outline PG-TO220-3, dimensions in mm/inches

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7 Appendix A

Table 11 Related Links

• IFX CoolMOS S7 Webpage: www.infineon.com

• IFX CoolMOS S7 application note: www.infineon.com

• IFX CoolMOS S7 simulation model: www.infineon.com

• IFX Design tools: www.infineon.com

IPP60R022S7



Revision History

IPP60R022S7

Revision: 2021-10-25, Rev. 2.1

Previous	Dovicion

1 10110401						
Revision	evision Date Subjects (major changes since last revision)					
2.0	2019-05-07	Release of final version				
2.1	2021-10-25	Change of wording regarding breakdown voltage / cosmic ray				

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